

Product Change Notice



PCN: PCN_KSM24RD4_32MAI_P

Date: June 21, 2019

Kingston Technology Company
17600 Newhope Street
Fountain Valley, CA 92708
USA

Type of Change: Phase Out for End of Life

Product(s) Affected: KSM24RD4/32MAI

Product Description: 32GB DDR4-2400 Registered DIMM CL17 2Rx4 1.2V Micron A Die with IDT (Server Premier)

JEDEC Specification: 32GB 2Rx4 PC4-2400T-RB2-11

Description of Change: Phase out due to DRAM die revision end of life. Replacement parts available.

Replacement Part(s): KSM24RD4/32MEI
32GB DDR4-2400 Registered DIMM CL17 2Rx4 1.2V Micron E Die with IDT (Server Premier)
32GB 2Rx4 PC4-2400T-RB2-11

KSM24RD4/32HCI
32GB DDR4-2400 Registered DIMM CL17 2Rx4 1.2V Hynix C Die w/IDT (Server Premier)
32GB 2Rx4 PC4-2400T-RB2-11

Phase Out Notice: June 21, 2019

Target EOL Date: September 18, 2019 *

* An increase in demand may cause the EOL date to be pulled in. Please contact your Kingston representative to forecast and assist with replacement part qualification.
